Very Low Forward Voltage Trench-based Schottky Rectifier

Exceptionally Low $V_F = 0.50$ V at $I_F = 5$ A

Features

- Fine Lithography Trench–based Schottky Technology for Very Low Forward Voltage and Low Leakage
- Fast Switching with Exceptional Temperature Stability
- Low Power Loss and Lower Operating Temperature
- Higher Efficiency for Achieving Regulatory Compliance
- Low Thermal Resistance
- High Surge Capability
- Pb-Free and Halide-Free Packages are Available

Typical Applications

- Switching Power Supplies including Notebook / Netbook Adapters, ATX and Flat Panel Display
- High Frequency and DC–DC Converters
- Freewheeling and OR-ing diodes
- Reverse Battery Protection
- Instrumentation

Mechanical Characteristics

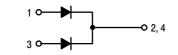
- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94-0 @ 0.125 in
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Maximum for 10 sec

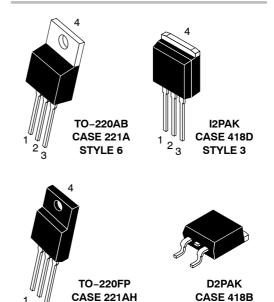


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PIN CONNECTIONS





ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

1

MAXIMUM RATINGS

| Rating | | | Value | Unit | |
|--|-------------------------|--|-------------|------|--|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | | V _{RRM} V _{RWM} V _R | 100 | V | |
| Average Rectified Forward Current (Rated V_R , T_C = 130°C) | Per device Per diode | I _{F(AV)} | 20 10 | A | |
| Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz, T_C = 125°C) | Per device Per diode | I _{FRM} | 40 20 | A | |
| Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz) | | I _{FSM} | 150 | A | |
| Operating Junction Temperature | | TJ | -40 to +150 | °C | |
| Storage Temperature | | T _{stg} | -40 to +150 | °C | |
| Voltage Rate of Change (Rated V _R) | | dv/dt | 10,000 | V/μs | |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

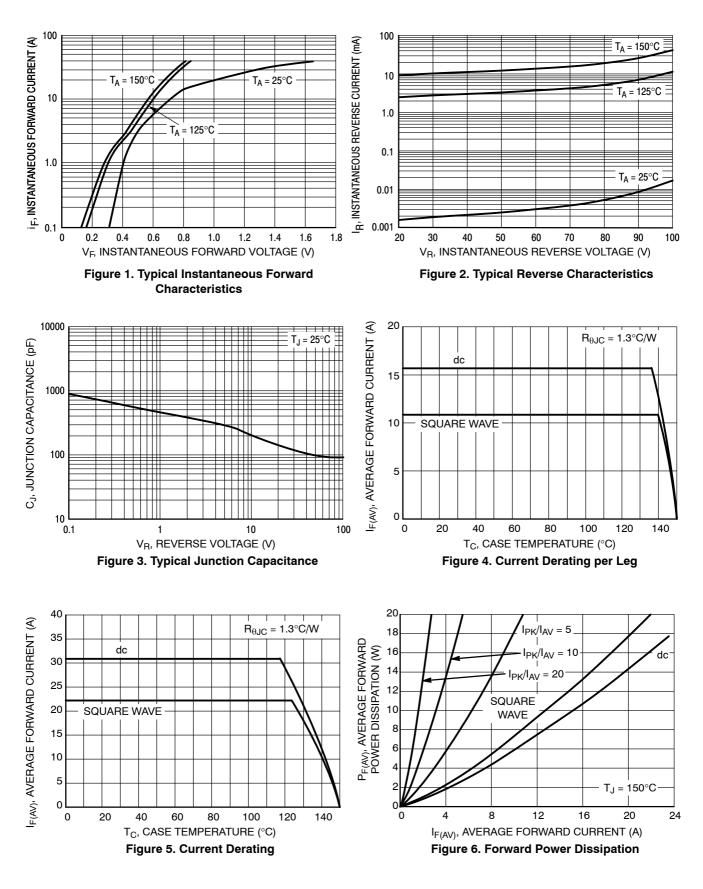
THERMAL CHARACTERISTICS

| Rating | Symbol | NTST20U100CTG, NTSB20U100CT-1G | NTSB20U100CTG | NTSJ20U100CTG | Unit |
|---|--------------------------------|-----------------------------------|---------------|---------------|--------------|
| Maximum Thermal Resistance per Diode Junction-to-Case Junction-to-Ambient | $R_{	heta JC} \\ R_{	heta JA}$ | 2.5 70 | 1.24 46.7 | 4.20 105 | °C/W °C/W |

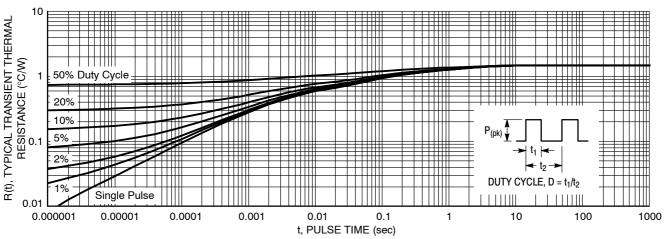
ELECTRICAL CHARACTERISTICS (Per Leg unless otherwise noted)

| Rating | Symbol | Тур | Мах | Unit |
|---|----------------|--------------|-----------|----------|
| Maximum Instantaneous Forward Voltage (Note 1) | ٧ _F | | | V |
| $(I_F = 5 \text{ A}, T_J = 25^{\circ}\text{C})$ $(I_F = 10 \text{ A}, T_J = 25^{\circ}\text{C})$ | | 0.55 0.65 | 0.79 | |
| $(I_F = 5 \text{ A}, T_J = 125^{\circ}\text{C})$ $(I_F = 10 \text{ A}, T_J = 125^{\circ}\text{C})$ | | 0.50 0.58 | _ 0.68 | |
| Maximum Instantaneous Reverse Current (Note 1) $(V_R = 70 \text{ V}, T_J = 25^{\circ}\text{C})$ $(V_R = 70 \text{ V}, T_J = 125^{\circ}\text{C})$ | I _R | 17 5.3 | | μA mA |
| (Rated dc Voltage, $T_J = 25^{\circ}C$) (Rated dc Voltage, $T_J = 125^{\circ}C$) | | _ 12 | 800 25 | μA mA |

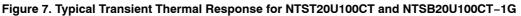
1. Pulse Test: Pulse Width = 300 $\mu s,$ Duty Cycle $\,\leq\,$ 2.0%

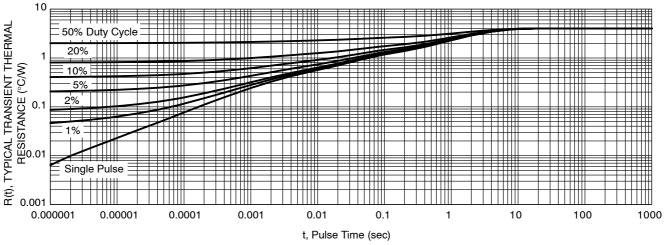


TYPICAL CHARACTERISITICS

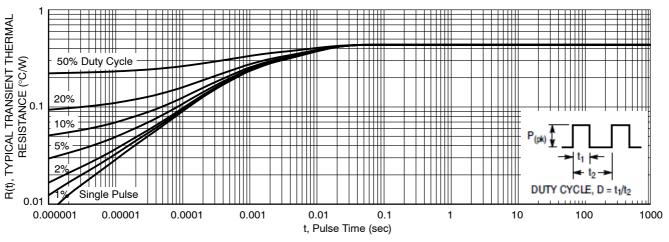


TYPICAL CHARACTERISITICS











ORDERING INFORMATION

| Device | Package | Shipping |
|-----------------|---|-------------------|
| NTST20U100CTG | TO-220AB (Pb-Free) | 50 Units / Rail |
| NTSB20U100CT-1G | I ² PAK 50 Units / Rail (Pb-Free) | |
| NTSJ20U100CTG | TO-220FP (Halide-Free) | 50 Units / Rail |
| NTSB20U100CTG | D ² PAK (Pb–Free) | 50 Units / Rail |
| NTSB20U100CTT4G | D ² PAK (Pb–Free) | 800 / Tape & Reel |

AYWW AYWW TS20U10CG AYWW AYWW TS20U10CG TS20U10Cx TS20U10CG AKA AKA AKA AKA I²PAK TO-220FP D²PAK TO-220AB

| Α | = Assembly Location |
|---|---------------------|

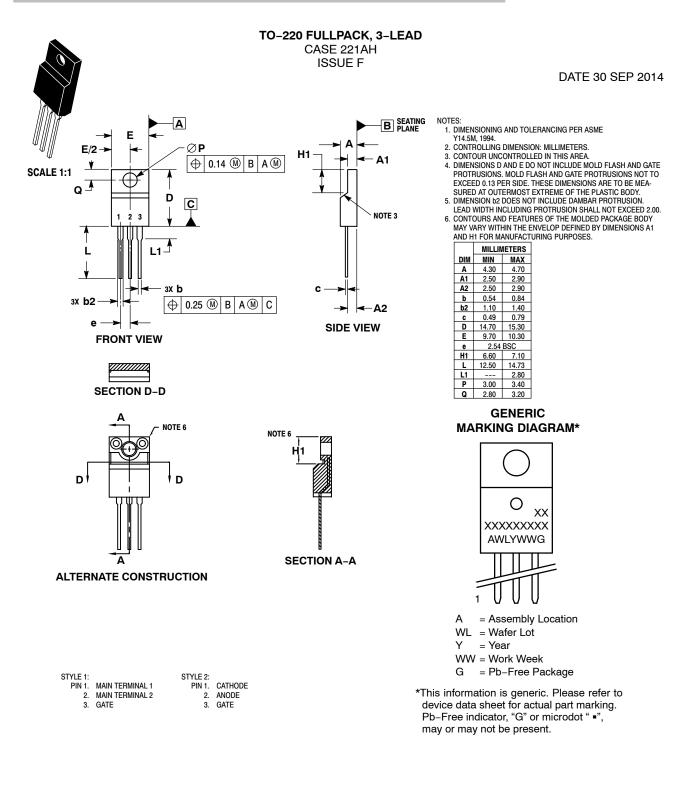
| / \ | - / 000011 |
|------------|------------|
| Y | = Year |

ww = Work Week

- AKA = Polarity Designator
- х = G or H
- G = Pb-Free Package
- Н = Halide-Free Package

MARKING DIAGRAMS

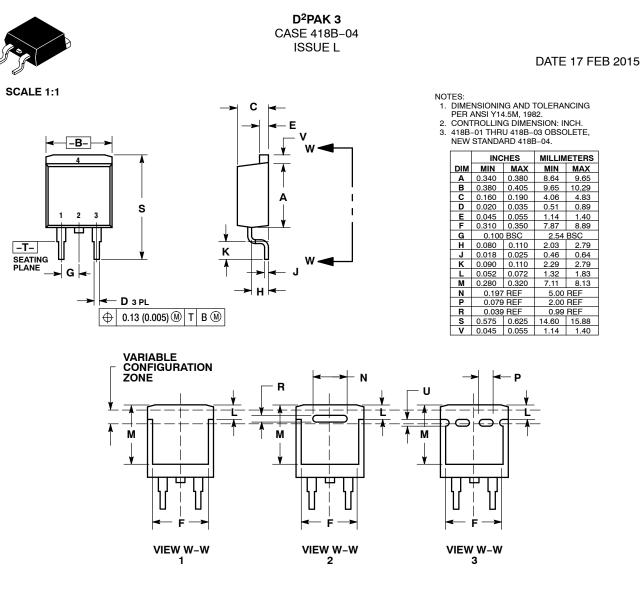




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| STYLE 1: | STYLE 2: | STYLE 3: | STYLE 4: | STYLE 5: | STYLE 6: |
|--------------|--------------------------|--------------|--------------|----------------|-------------------|
| PIN 1. BASE | PIN 1. GATE | PIN 1. ANODE | PIN 1. GATE | PIN 1. CATHODE | PIN 1. NO CONNECT |
| 2. COLLECTOR | 2. DRAIN | 2. CATHODE | 2. COLLECTOR | 2. ANODE | 2. CATHODE |
| 3. EMITTER | SOURCE | 3. ANODE | 3. EMITTER | 3. CATHODE | 3. ANODE |
| 4. COLLECTOR | 4. DRAIN | 4. CATHODE | 4. COLLECTOR | 4. ANODE | 4. CATHODE |
| | | | | | |

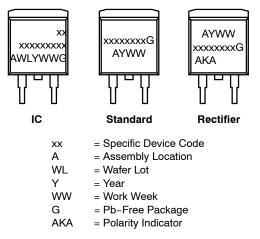
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D²PAK 3 CASE 418B-04 ISSUE L

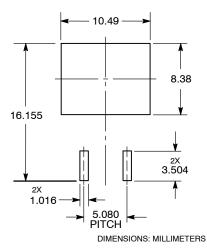
DATE 17 FEB 2015

GENERIC MARKING DIAGRAM*



*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present.

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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